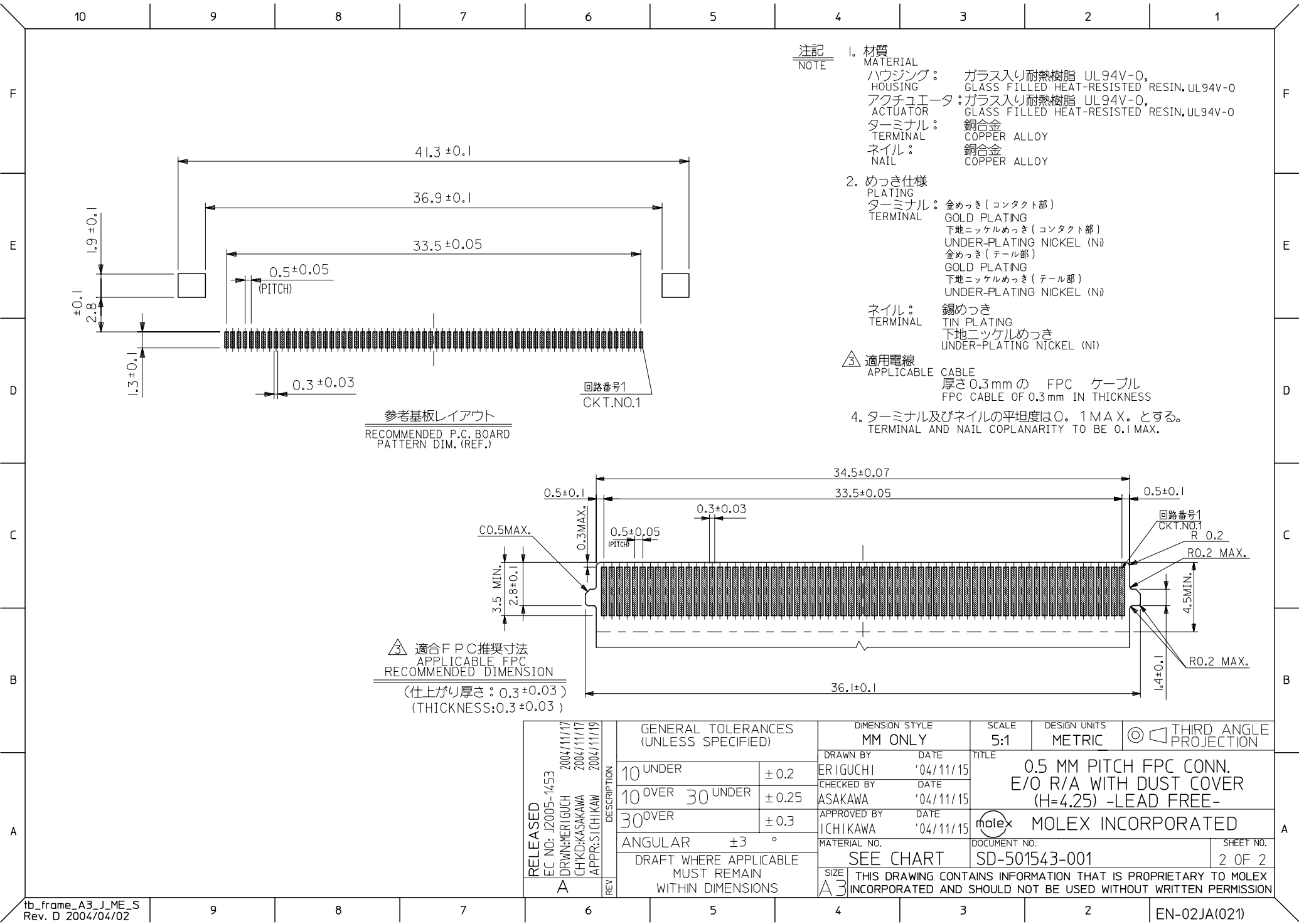




注記
NOTE

1. 材質
MATERIAL
ハウジング: ガラス入り耐熱樹脂 UL94V-0,
HOUSING GLASS FILLED HEAT-RESISTED RESIN, UL94V-0
アクチュエータ: ガラス入り耐熱樹脂 UL94V-0,
ACTUATOR GLASS FILLED HEAT-RESISTED RESIN, UL94V-0
ターミナル: 銅合金
TERMINAL COPPER ALLOY
ネイル: 銅合金
NAIL COPPER ALLOY

2. めっき仕様
PLATING
ターミナル: 金めっき (コンタクト部)
TERMINAL GOLD PLATING
下地ニッケルめっき (コンタクト部)
UNDER-PLATING NICKEL (Ni)
金めっき (テール部)
GOLD PLATING
下地ニッケルめっき (テール部)
UNDER-PLATING NICKEL (Ni)
ネイル: 錫めっき
TERMINAL TIN PLATING
下地ニッケルめっき
UNDER-PLATING NICKEL (Ni)

3. 適用電線
APPLICABLE CABLE
厚さ 0.3 mm の FPC ケーブル
FPC CABLE OF 0.3 mm IN THICKNESS

4. ターミナル及びネイルの平坦度は 0.1 MAX. とする。
TERMINAL AND NAIL COPLANARITY TO BE 0.1 MAX.

△ 適合 FPC 推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION
(仕上がり厚さ: 0.3 ± 0.03)
(THICKNESS: 0.3 ± 0.03)

RELEASED EC NO: J2005-1453 DRAWN: ERIGUCHI CHKD: KASAKAWA APPR: S. ICHIKAWA	2004/11/17 2004/11/17 2004/11/19	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
			10 UNDER	± 0.2	DRAWN BY ERIGUCHI	DATE '04/11/15	TITLE 0.5 MM PITCH FPC CONN. E/O R/A WITH DUST COVER (H=4.25) -LEAD FREE-  MOLEX INCORPORATED			
			10 OVER 30 UNDER	± 0.25	CHECKED BY ASAKAWA	DATE '04/11/15				
			30 OVER	± 0.3	APPROVED BY ICHIKAWA	DATE '04/11/15				
			ANGULAR ± 3 °		MATERIAL NO. SEE CHART					DOCUMENT NO. SD-501543-001
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

DETAIL "F"

CONNECTOR No. : 501543-6819

EN-02JA(021)

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

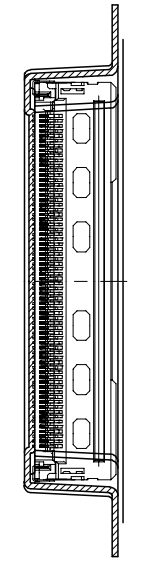
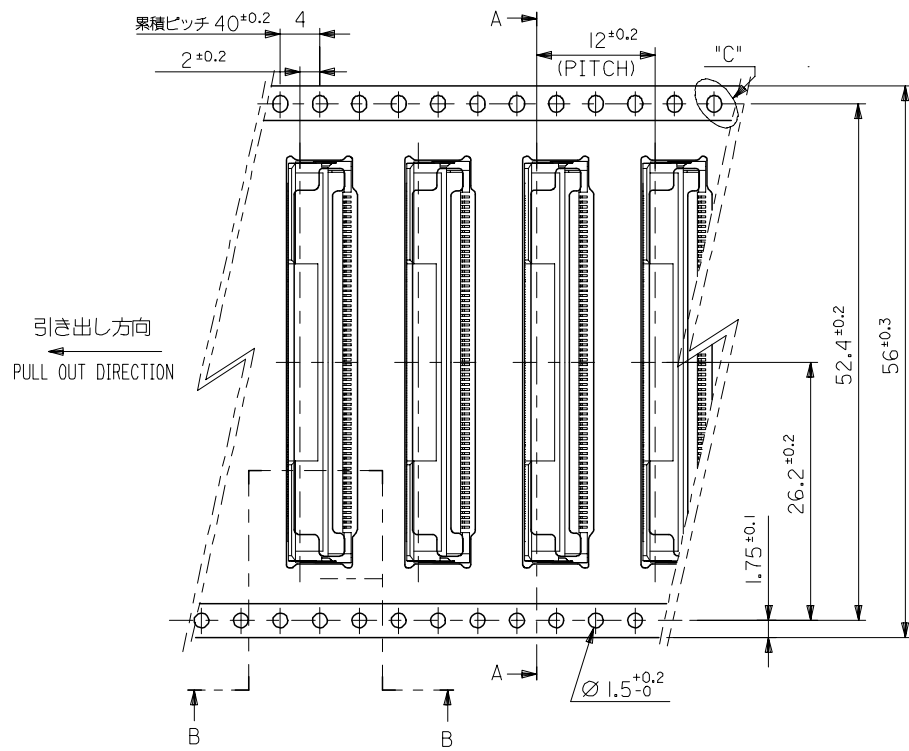
E

D

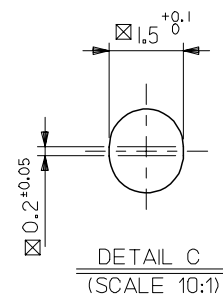
C

B

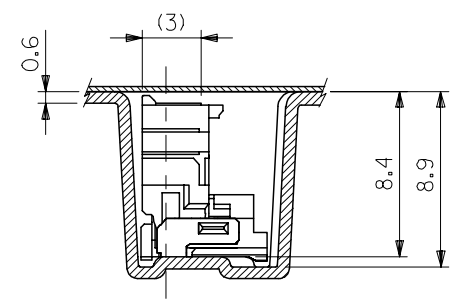
A



SECTION A-A



DETAIL C
(SCALE 10:1)



SECTION B-B
(SCALE 4:1)

RELEASED EC NO: J2005-1453 DRAWN: ERIGUCHI 2004/11/17 CHKD: KASAKAWA 2004/11/17 APPR: S ICHIKAWA 2004/11/19 A	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY ERIGUCHI	DATE '04/11/15	TITLE 0.5 FPC CONN. E/O R/A ASS'Y EMBSTP PKG. WITH DUST COVER -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY ASAKAWA	DATE '04/11/15					
		30 OVER	±0.3	APPROVED BY ICHIKAWA	DATE '04/11/15	MOLEX MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-501543-002		2 OF 2		
				SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				